

Package: SOP

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1. Structure and materials

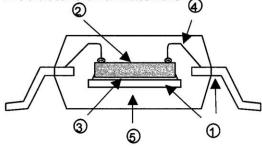


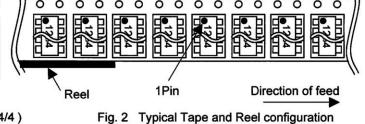
Fig. 1 Structure

No.	Item	Materials
Ð	Lead Frame	SOP8 , SOP-J8 to -J14 : Cu-Alloy (External lead : Pb free solder plating) except SOP8 , SOP-J8 to -J14 : Alloy42 (External lead : Pb free solder plating)
2	Die	Silicon
3	Die Attach	Ag Paste
4	Wire	Au
6	Molding	Epoxy Resin

2. Tape and Reel information

2. 1. Packing specification

Таре	Embossed carrier tape	
Quantity	See the table on page 4/4	
Direction of feed	E2 (See Fig. 2)	



2. 2. Tape and Reel specification

2. 2. 1. Tape and reel dimensions (See the table on page 4/4)

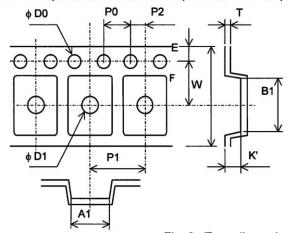


Fig. 3 Tape dimensions

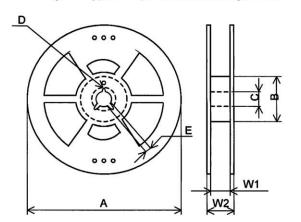


Fig. 4 Reel dimensions

2. 3. Leader and Trailer

2. 3. 1. Leader

No component pockets are 40 pockets or more.

2. 3. 2. Trailer

No component pockets are 10 pockets or more. Tape is free from reel.

2. 4. Label for Reel and Box

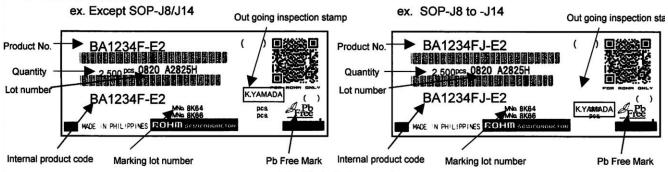


Fig. 5 Label example

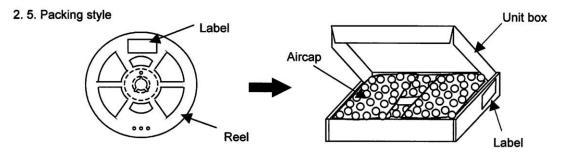
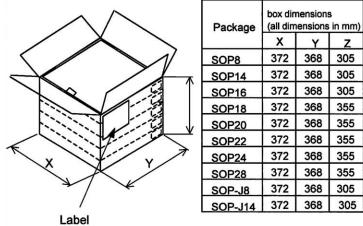


Fig. 6 Packing style

2. 6. Shipping style

5 unit boxes or less per shipping box



2. 7. Packing materials

Item	Material				
Embossed carrier tape	PS				
Cover tape	PET + PE				
Reel	PS				
Air cap	Polyethylene				
Unit box	Cardboard				
Shipping box	Cardboard				

^{*} Please obey the indication of top side in a shipping box.

(all dimensions in mm)

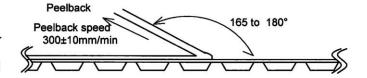
Fig. 7 Shipping box dimensions and Shipping style

2. 8. Others

2. 8. 1. Peelback strength

Cover tape peelback strength is 0.2 to 0.7N.

Fig. 8 Test method



2. 8. 2. Missing Ics

- (1) No consecutive dropouts.
- (2) A maximun 0.1% of specified number of products in each packing may be missing.

3. Storage conditions

3. 1. Storage environment

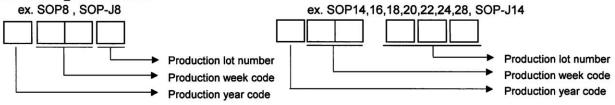
Recommended storage conditions are as follows:

-Temperature : 5 to 30°C -Humidity : 40 to 70% RH

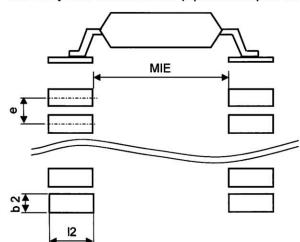
3. 2. Storage period

-Specified storage period : 1 year

4. Marking lot number



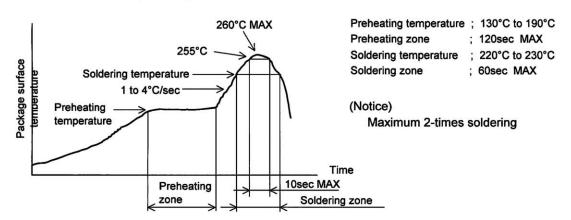
5. Footprint dimensions (Optimize footprint dimensions to the board design and soldering condition)



(all dimensions in							
Package	Land pitch e	Land space MIE	Land length ≥ I2	Land width b2			
SOP8 to 16	1.27	4.60	1.10	0.76			
SOP18 to 24	1.27	6.00	1.20	0.76			
SOP28	1.27	8.10	1.20	0.76			
SOP-J8 to J14	1.27	3.90	1.35	0.76			

6. Soldering conditions

6. 1. Recommended temperature profile for reflow



6. 2. Recommended condition for wave soldering

Drassa	Conditions					
Process	Temperature	Time				
Preheating	120°C to 150°C	60sec MAX				
Soldering	260°C ± 3°C	12sec MAX				

(Notice) Soldering time is provided for total soldering time in case of dual wave soldering.

6. 2. 1. Notes for wave soldering

- (1) Do not use other soldering methods with wave soldering.
- (2) Recommend to clean the board to eliminate flux, solder waste, and other impurities for reliability, after soldering.
- (3) Optimize soldering condition to prevent solder bridging.

6. 3. Recommended condition for solder iron

Recommended condition for solder iron
-Solder iron temperature : 380°C or less
-Mounting time : 4sec or less

< Tape dimensions >

Doelsone	Quantity	Tape dimensions (all dimensions in mm)											
Package	(pcs)	A1	B1	D0	D1	Е	F	K'	P1	P2	Т	W	P0
SOP8	2500	6.8	5.5	φ1.5	φ1.5	1.75	5.5	2.0	8.0	2.0	0.3	12.0	4.0
SOP14	2500	6.8	9.3	φ1.5	φ1.5	1.75	7.5	2.1	8.0	2.0	0.3	16.0	4.0
SOP16	2500	6.8	10.6	φ1.5	φ1.5	1.75	7.5	2.1	8.0	2.0	0.3	16.0	4.0
SOP18	2000	8.4	12.0	φ1.5	φ2.0	1.75	11.5	2.1	12.0	2.0	0.3	24.0	4.0
SOP20	2000	8.4	12.95	ф1.5	ф2.0	1.75	11.5	2.15	12.0	2.0	0.3	24.0	4.0
SOP22	2000	8.4	14.5	φ1.5	ф2.0	1.75	11.5	2.3	12.0	2.0	0.3	24.0	4.0
SOP24	2000	8.5	15.6	ф1.5	φ2.0	1.75	11.5	2.15	12.0	2.0	0.3	24.0	4.0
SOP28	1500	10.7	18.9	φ1.5	ф2.0	1.75	11.5	3.0	16.0	2.0	0.3	24.0	4.0
SOP-J8	2500	6.8	5.5	φ1.5	φ1.5	1.75	5.5	2.0	8.0	2.0	0.3	12.0	4.0
SOP-J14	2500	6.55	9.15	φ1.5	φ1.5	1.75	7.5	1.8	8.0	2.0	0.3	16.0	4.0
Tolera	ance	±0.1	±0.1	+0.1 -0	MIN	±0.1	±0.1	±0.1	±0.1	±0.1		±0.3	±0.1

< Reel dimensions >

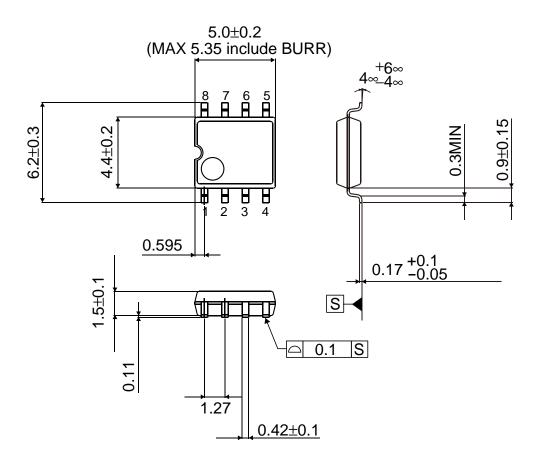
Doolsooo	Reel dimensions (all dimensions in mm)								
Package	Α	В	С	D	Е	W1	W2		
SOP8	ф330	ф80	φ13.0	ф20.2	1.5	12.4	20.4		
SOP14	ф330	ф80	φ13.0	ф20.2	1.5	16.4	24.4		
SOP16	ф330	ф80	φ13.0	ф20.2	1.5	16.4	24.4		
SOP18	ф330	ф80	φ13.0	φ20.2	1.5	24.5	32.4		
SOP20	ф330	ф80	φ13.0	ф20.2	1.5	24.5	32.4		
SOP22	ф330	ф80	ф13.0	ф20.2	1.5	24.5	32.4		
SOP24	ф330	ф80	ф13.0	ф20.2	1.5	24.5	32.4		
SOP28	ф330	ф80	φ13.0	ф20.2	1.5	24.5	32.4		
SOP-J8	ф330	ф80	φ13.0	ф20.2	1.5	12.4	20.4		
SOP-J14	ф330	ф80	ф13.0	ф20.2	1.5	16.4	24.4		
Tolerance	-		±0.2	MIN	MIN	+2.0	MAX		

< Dehydrated weight >

Dehydrated weight dimensions in g
0.084
0.14
0.16
0.26
0.28
0.31
0.34
0.67
0.08
0.12

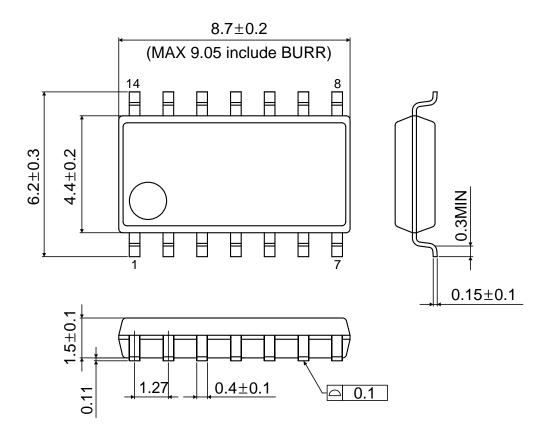


SOP8



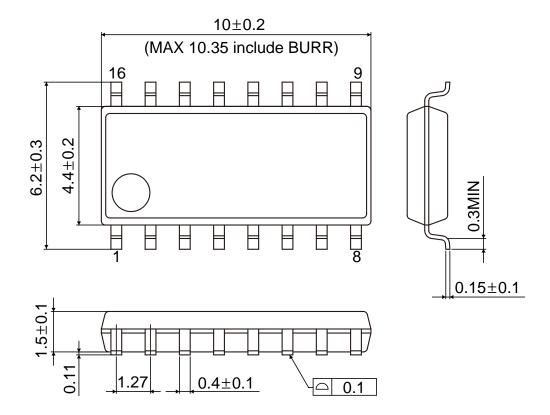


SOP14



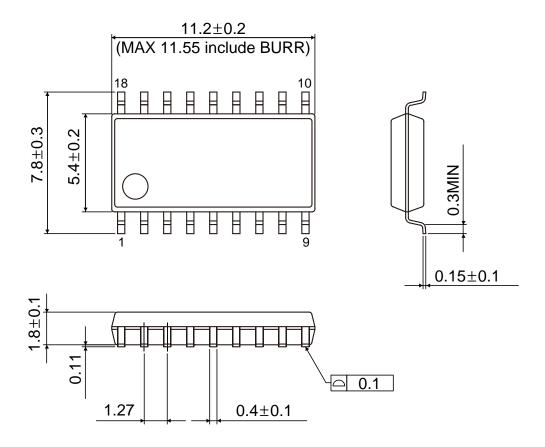


SOP16



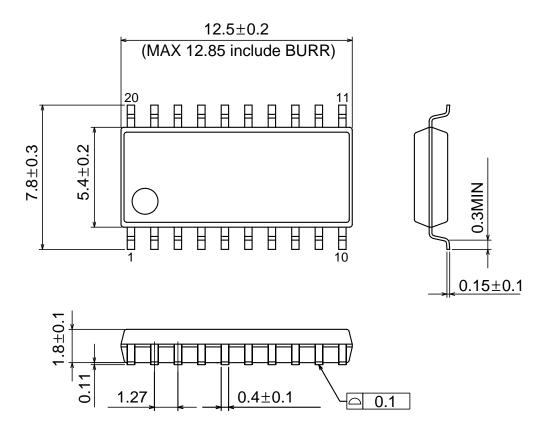


SOP18



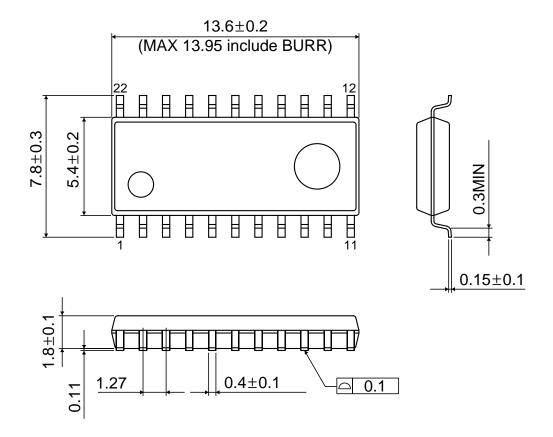


SOP₂₀



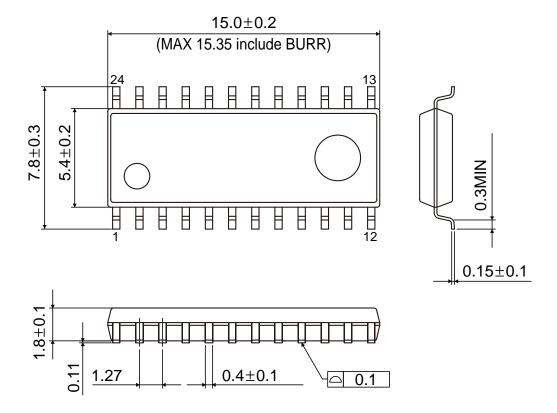


SOP22



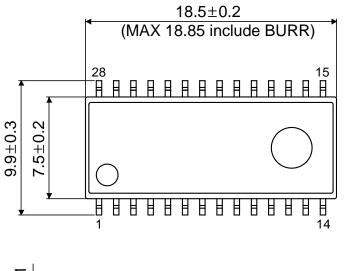


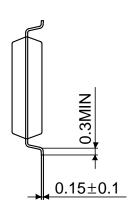
SOP24

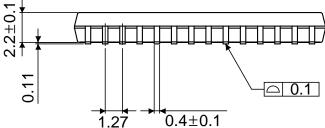




SOP28

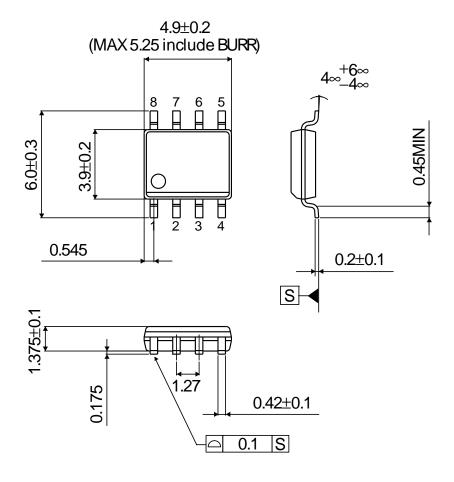






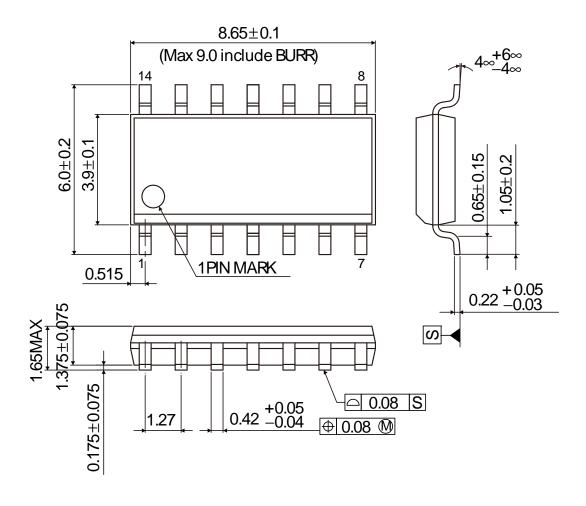


SOP-J8 / 8lead JEDECSOIC / S.O Package 8 / SO Package 8 / SOIC8





SOP-J14 / S.O Package 14 / SO Package 14 / SOIC14



Notes

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